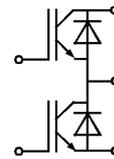
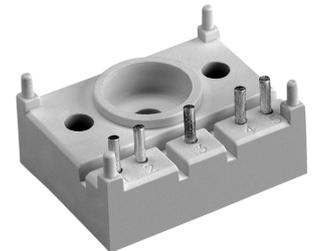


SEMITOP® 1 Fast IGBT Module

SK 25 GB 065

Absolute Maximum Ratings			
Symbol	Conditions ¹⁾	Values	Units
V _{CES}		600	V
V _{GES}		± 20	V
I _C	T _h = 25/80 °C	30 / 21	A
I _{CM}	t _p < 1 ms; T _h = 25/80 °C	60 / 42	A
I _F = -I _C	T _h = 25/80 °C	36 / 24	A
I _{FM} = -I _{CM}	t _p < 1 ms; T _h = 25/80 °C	72 / 48	A
T _j		- 40 ... + 150	°C
T _{stg}		- 40 ... + 125	°C
T _{sol}	Terminals, 10 s	260	V
V _{isol}	AC, 1 min	2500	V

Characteristics					
Symbol	Conditions ¹⁾	min.	typ.	max.	Units
V _{CEsat}	I _C = 20 A; T _j = 25 (125) °C	-	1,8(2,1)	2,0(2,2)	V
t _{d(on)}	V _{CC} = 300 V; V _{GE} = ± 15 V	-	30	-	ns
t _r	I _C = 25 A; T _j = 125 °C	-	25	-	ns
t _{d(off)}	R _{Gon} = R _{Goff} = 33 Ω	-	250	-	ns
t _f	inductive load	-	15	-	ns
E _{on} + E _{off}		-	1,35	-	mJ
C _{ies}	V _{CE} = 25 V; V _{GE} = 0 V, 1 MHz	-	1,6	-	nF
R _{thjh} ³⁾	per IGBT	-	-	1,4	K/W
Inverse Diode ²⁾					
V _F = V _{EC}	I _F = 25 A; T _j = 25 (125) °C	-	1,45(1,4)	1,7(1,75)	V
V _{TO}	T _j = 125 °C	-	0,85	0,9	V
r _T	T _j = 125 °C	-	22	32	mΩ
I _{RRM}	I _F = 25 A; V _R = 300 V	-	16	-	A
Q _{rr}	di _F /dt = - 500 A/μs	-	2	-	μC
E _{off}	V _{GE} = 0 V; T _j = 125 °C	-	0,25	-	mJ
R _{thjh} ³⁾	per Diode	-	-	1,7	K/W
Mechanical Data					
M1	mounting torque	-	-	1,5	Nm
w		-	13	-	g
Case			T 3		



GB

Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- N-channel homogeneous silicon structure (NPT-Non punch-through IGBT)
- Low tail current with low temperature dependence
- Low threshold voltage
- UL recognized, file no. E 63 532

Typical Applications

- Switching (not for linear use)
- Inverter
- Switched mode power supplies
- UPS

¹⁾ T_h = 25 °C, unless otherwise specified

²⁾ CAL = Controlled Axial Lifetime Technology (soft and fast recovery)

³⁾ Thermal resistance junction to heatsink

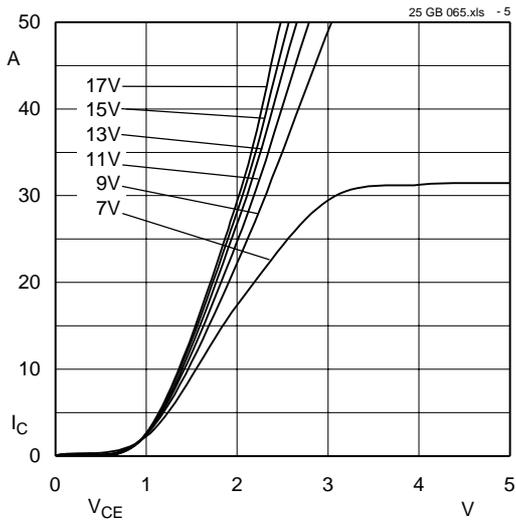


Fig. 5 Typ. output characteristic, $t_p = 80 \mu s$; $25 \text{ }^\circ\text{C}$

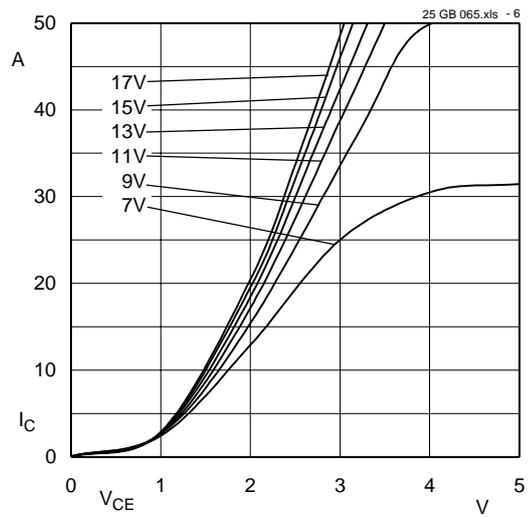


Fig. 6 Typ. output characteristic, $t_p = 80 \mu s$; $125 \text{ }^\circ\text{C}$

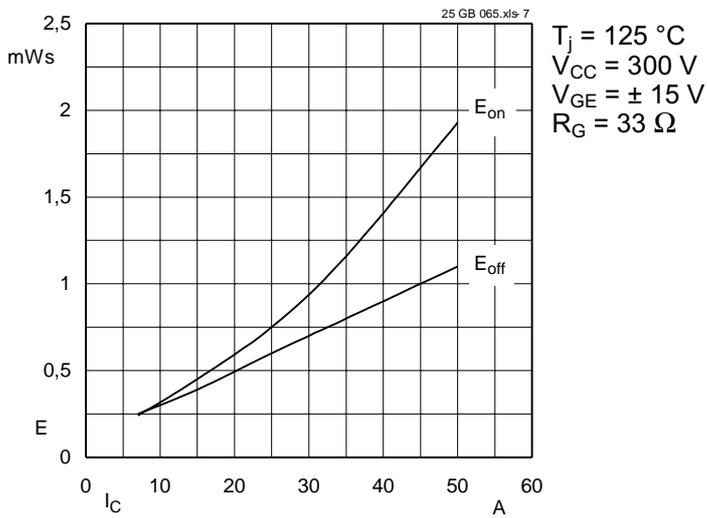


Fig. 7 Turn-on /-off energy = $f(I_c)$

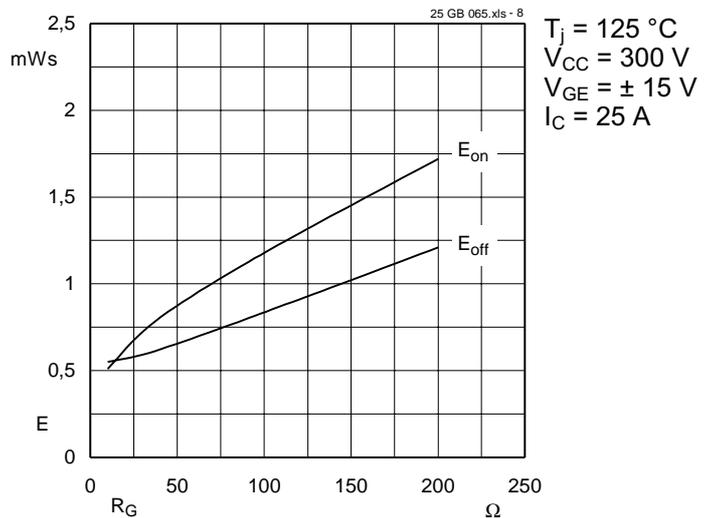


Fig. 8 Turn-on /-off energy = $f(R_G)$

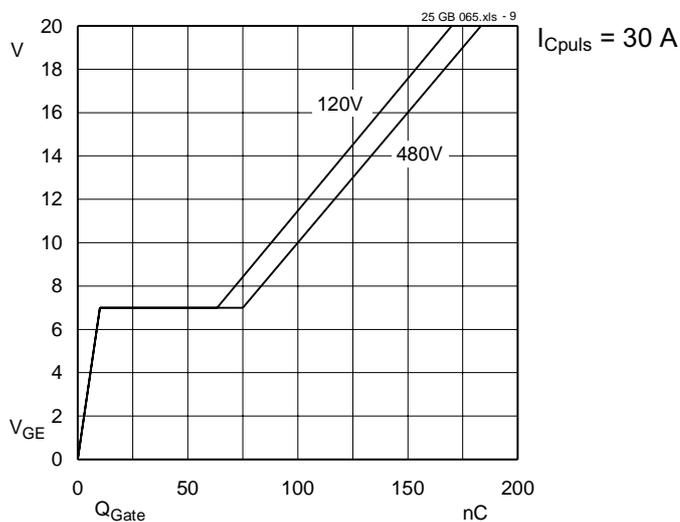


Fig. 9 Typ. gate charge characteristic

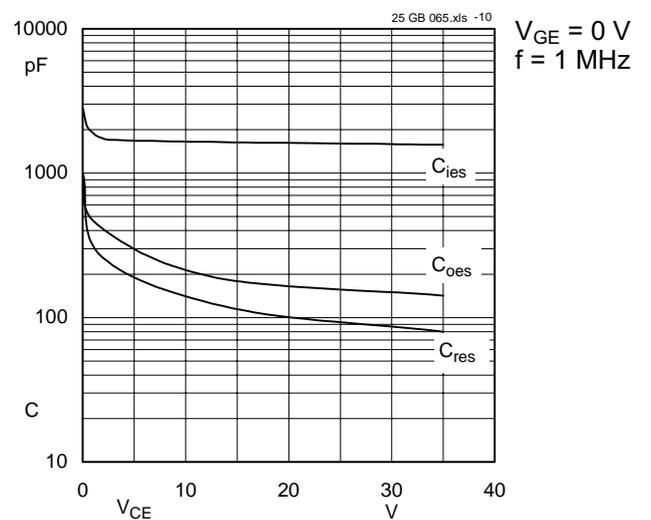


Fig. 10 Typ. capacitances vs. V_{CE}

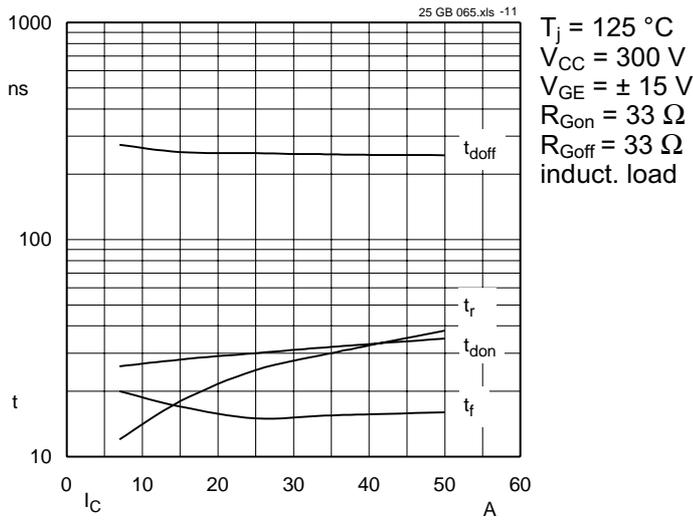


Fig. 11 Typ. switching times vs. I_C

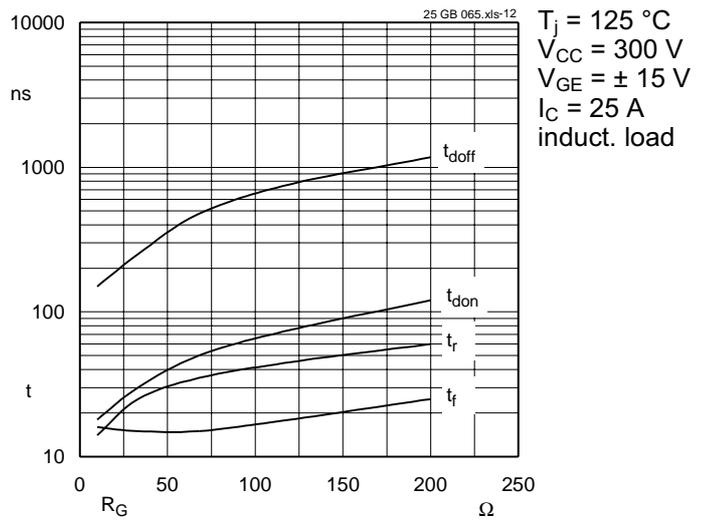


Fig. 12 Typ. switching times vs. gate resistor R_G

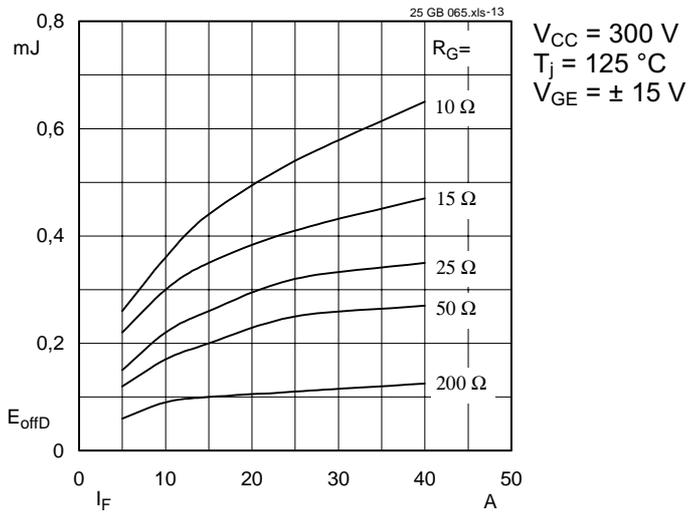
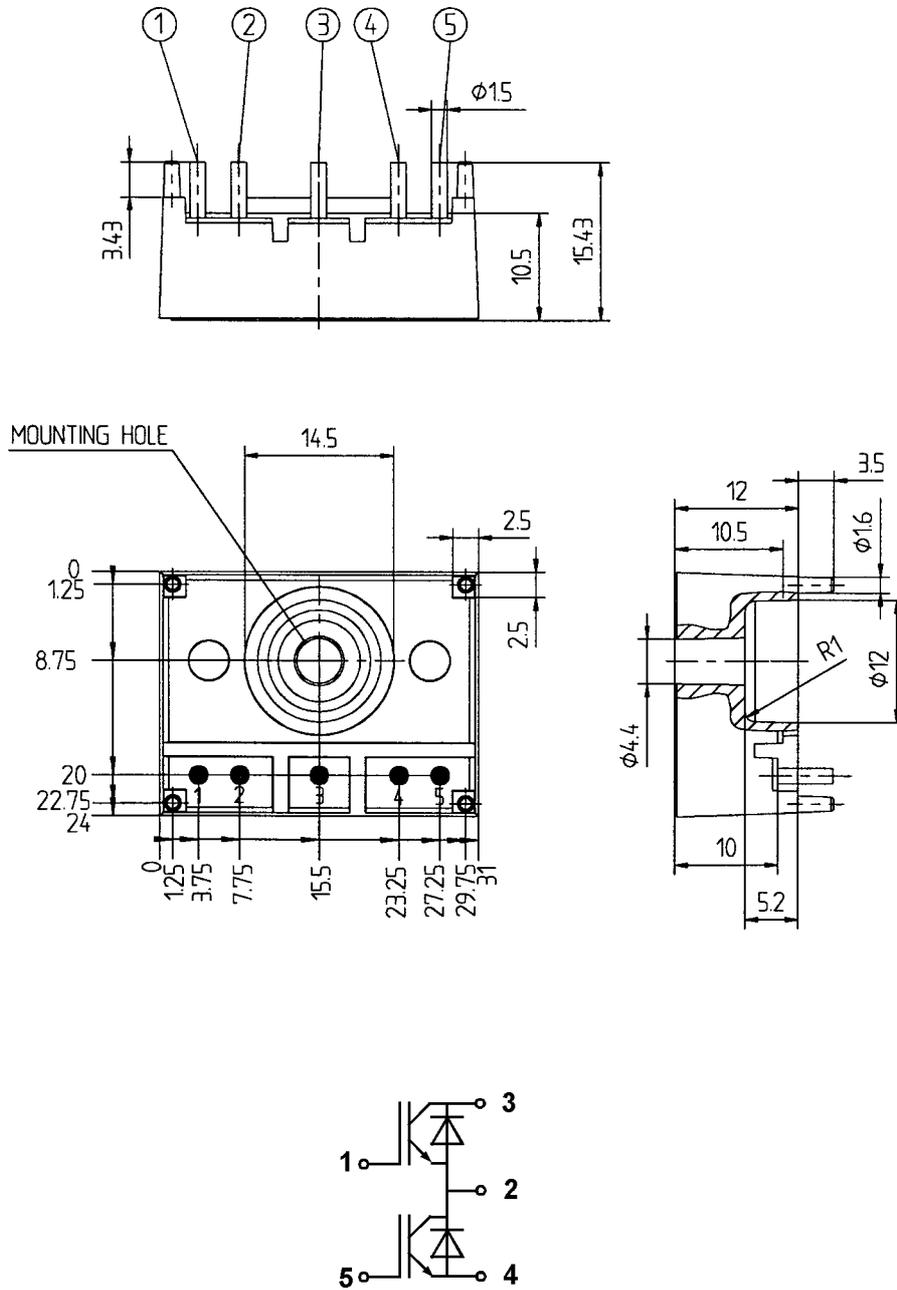


Fig. 13 Diode turn-off energy dissipation per pulse

SEMITOP® 1
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Case T 3



Dimensions in mm